

## PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mitsubishi Materials Corporation	07/30/2008
RECEIVING PARTY DATA	
Name:	SUMCO CORPORATION
Street Address:	2-1, Shibaura 1-Chome, Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	105-8634
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	5616507
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PATENT  
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# ASSIGNMENT

WHEREAS, **Mitsubishi Materials Corporation**, a corporation of **Japan**, whose post office address is **5-1, Ohtemachi 1-Chome, Chiyoda-Ku, Tokyo, Japan**, hereinafter referred to as the **ASSIGNOR**, is an owner, together with **Mitsubishi Denki Kabushiki Kaisha** of U.S. Letters Patent No. **5,616,507**, entitled **Method of Manufacturing Substrate Having Semiconductor on Insulator** by means of an assignment recorded effective **June 9, 1993** at Reel **006565**, Frame **0697** of the U.S. Patent and Trademark Office assignment records for parent U.S. Patent No. **5,441,899**.

AND WHEREAS, **SUMCO CORPORATION**, a corporation organized and existing under the laws of **Japan**, whose post-office address is **2-1, Shibaura 1-Chome, Minato-ku, Tokyo 105-8634 Japan**, hereinafter known as the **ASSIGNEE**, is desirous of acquiring the entire right, title and interest of said **ASSIGNOR** for the United States and elsewhere throughout the world in and to said Letters Patent, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said **ASSIGNOR** hereby assigns, sells and transfers to said **ASSIGNEE**, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said Letters Patent, for the United States, and elsewhere throughout the world, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said **ASSIGNEE** and its assigns and legal representatives to have, hold, exercise and enjoy the said Letters Patent, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said **ASSIGNEE** and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said **ASSIGNOR** might or could have held and enjoyed the same, if this assignment had not been made.

AND said **ASSIGNOR** hereby agrees to execute all papers necessary to file applications in the United States, and elsewhere throughout the world, for said Letters Patent and to assign the same to said **ASSIGNEE**, or any assignee acquiring title to said Letters Patent, and to execute any other papers that may be needed in connection with securing further Letters Patent thereon.

AND said **ASSIGNOR** authorizes and requests the Commissioner of Patents to issue Letters Patent, and any and all divisions and continuations thereof, to said **ASSIGNEE**, its assigns and legal representatives, in accordance herewith.


IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

Kazuo Kamiya  
(Name)

2008; 7. 30  
(Date)

Mitsubishi Materials Corporation

  
Name Akihiko IDE  
Title President

July 30, 2008  
DATE

Second Witness:

Shoji Oan  
(Name)

July 30, 2008  
(Date)